## **CLAIMS**

What is claimed is:

1. A method of removing technetium from a contaminated metal comprising:

providing a disc-shaped metal wafer as an anode in an electro-refining cell having a cathode and an anolyte solution; and

energizing the anode and cathode to dissolve the anode and deposit metal dissolved from the anode upon the cathode.

- 2. The method of claim 1 further comprising the operation of cutting one or more disc-shaped wafers from a contaminated metal ingot.
- 3. The method of claim 1 further comprising selectively preventing pertechnetate ions from collecting upon the cathode.
- 4. The method of claim 3 wherein pertechnetate ions are selectively prevented from collecting upon the cathode by cationic membrane filtering.
- 5. The method of claim 1 further comprising the operation of flowing said anolyte solution through a technetium trap outside of said electro-refining cell to remove pertechnetate ions from the anolyte solution.

- 6. The method of claim 5 wherein the analyte solution is flowed through the technetium trap by a fluid pump.
- 7. The method of claim 5 further comprising the operation of flowing the analyte solution through a particulate filter to remove particulate matter.
- 8. The method of claim 5 wherein the technetium trap comprises an electrolytic cell that collects technetium upon a second cathode.
- 9. The method of claim 1 wherein the metal comprises nickel.
- 10. A method of decontaminating a cylindrical metal ingot contaminated with technetium comprising:

cutting an ingot to provide one or more disc-shaped wafers;

providing one of said wafers as an anode in an electro-refining cell having an anolyte solution, and a cathode chamber containing a catholyte solution with a cathode disposed therein; dissolving the anode within the anolyte solution; and depositing metal dissolved from the anode upon the cathode.

11. The method of claim 10 further comprising the operation of filtering technetium from the analyte solution.

- 12. The method of claim 11 wherein the operation of filtering technetium from the analyte solution comprises flowing the analyte solution outside of the electro-refining cell, through a technetium trap to remove pertechnetate ions from solution, and then returning the analyte solution to the electro-refining cell.
- 13. The method of claim 11 wherein the operation of filtering technetium from the analyte solution comprises filtering out pertechnetate ions through a cationic membrane.
- 14. The method of claim 10 wherein the cathode comprises a rectangular plate.
- 15. The method of claim 10 further comprising the operation of securing the wafer anode to a supporting header plate by welding.
- 16. The method of claim 10 wherein the operation of depositing metal dissolved from the anode further comprises transmitting metal ions through the catholyte solution to the cathode.
- 17. A method for removing technetium from nickel and other transition metals comprising:

  providing substantially pure nickel in the form of a substantially cylindrical ingot;

  cutting at least one disc-shaped wafer from the ingot;

  providing said wafer as an anode in an electro-refining cell having a cathode and an anolyte solution;

dissolving the anode within the anolyte solution; and depositing metal dissolved from the anode upon the cathode.

- 18. The method of claim 17 wherein the ingot is formed by molding and cooling of the ingot from the radial outer surface and progressing radially inwardly.
- 19. The method of claim 16 further comprising the operation of removing technetium from the analyte solution by transmitting the analyte solution through a technetium trap.
- 20. The method of claim 17 wherein the operation of depositing metal upon the cathode further comprises transmitting metal ions from the analyte solution to a catholyte solution through a membrane.